

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

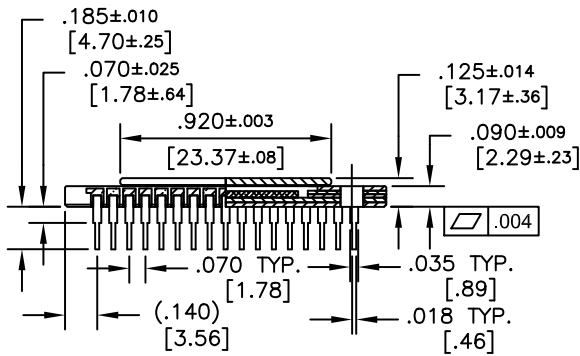
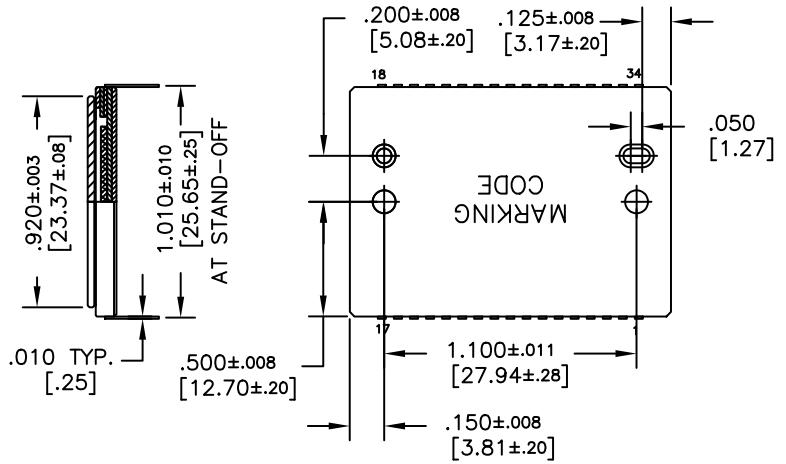
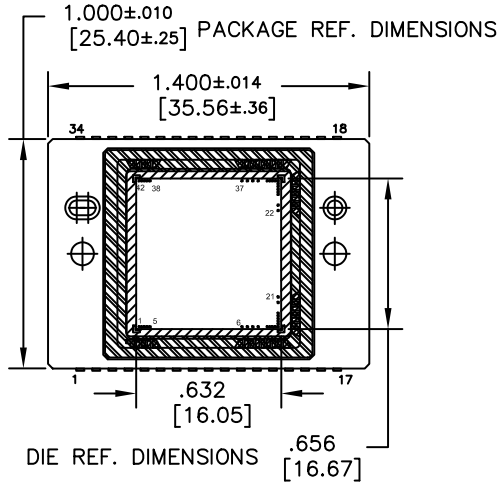
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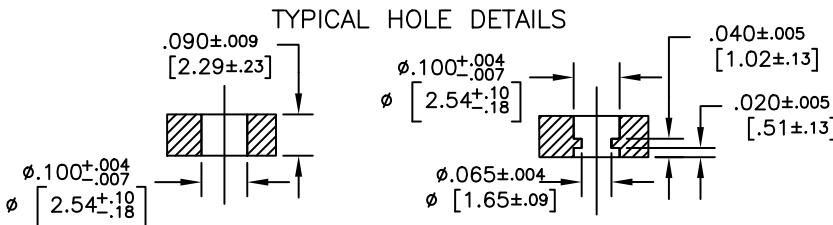
CERAMIC DIP 34, 35.56x20.83

CASE 125BJ
ISSUE O

DATE 03 JUL 2014



NOTES:
 1. COVER GLASS IS MANUALLY PLACED AND ALIGNED WITH THE AID OF A MECHANICAL FIXTURE.

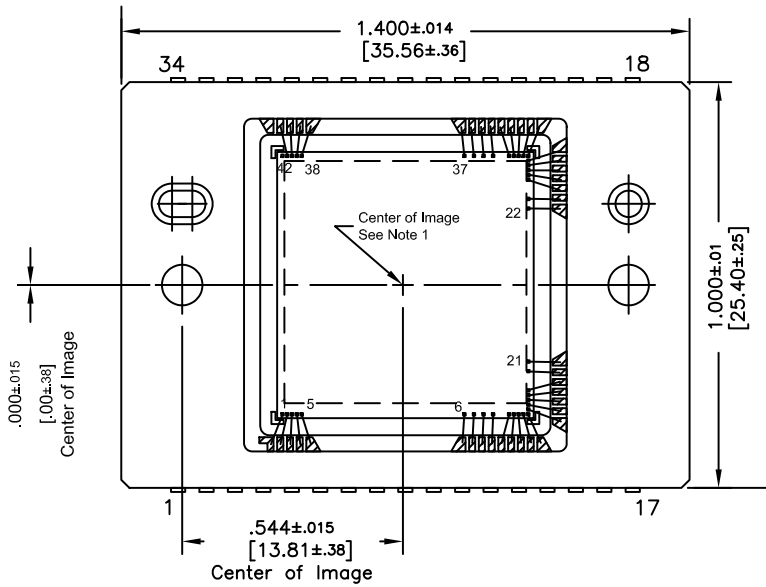


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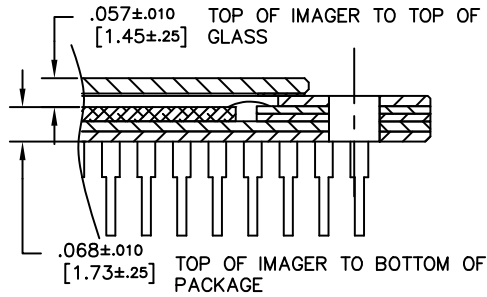
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